

AD8417-2

1 mm × 1.9 mm WLCSP, High Common-Mode, Bidirectional, Zero Drift, Current Sense Amplifier

FEATURES

- ▶ Typical 0.1 µV/°C offset drift
- ► Maximum ±400 µV voltage offset over full temperature range
- ▶ 2.7 V to 5.5 V power supply operating range
- ▶ Electromagnetic interference (EMI) filters included
- ► High common-mode input voltage range
- ► -2 V to +42 V continuous
- Initial gain = 60 V/V
- ▶ Wide operating temperature range: -40°C to +125°C
- Bidirectional operation
- ▶ Dual channel in a small 1 mm × 1.9 mm WLCSP
- ▶ Common-mode rejection ratio (CMRR): 86 dB, dc to 10 kHz

APPLICATIONS

- ▶ High-side current sensing in:
 - Motor controls
 - Solenoid controls
 - Power management
- ► Low-side current sensing
- Diagnostic protection

TYPICAL APPLICATION CIRCUIT



Figure 1. 3-Phase Motor Control

FUNCTIONAL BLOCK DIAGRAM



Figure 2. Functional Block Diagram

GENERAL DESCRIPTION

The AD8417-2 is a high voltage, high resolution, and dual channel current sense amplifier. It features an initial gain of 60 V/V, with a maximum $\pm 0.3\%$ gain error over the entire temperature range. The AD8417-2 performs bidirectional current measurements across a shunt resistor in a variety of applications, including motor control, power management, and solenoid control.

The AD8417-2 offers breakthrough performance throughout the -40° C to $+125^{\circ}$ C temperature range. It features a zero drift core, which leads to a typical offset drift of 0.1 μ V/°C throughout the operating temperature range and the common-mode voltage range. The device includes EMI filters and patented circuitry to enable output accuracy with pulse-width modulation (PWM) type input common-mode voltages. The typical input offset voltage is ±200 μ V.

The AD8417-2 is offered in a small 10-ball 1 mm × 1.9 mm WLCSP. It requires a smaller board area than a typical single-channel current sense amplifier, increasing channel density, without compromising performance.

Table	1.	Related	Devices

Part No.	Description		
AD8205	Current sense amplifier, gain = 50		
AD8206	Current sense amplifier, gain = 20		
AD8207	High accuracy current-sense amplifier, gain = 20		
AD8210	High speed current sense amplifier, gain = 20		
AD8417	High accuracy current sense amplifier, gain = 60		
AD8418A	High accuracy current sense amplifier, gain = 20		

Rev. B

DOCUMENT FEEDBACK

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REVISION HISTORY

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Changes to Figure 3	5
Changes to Table 5	5
Change to 3-Phase Motor Control Section	13
Added Layout Recommendation Section	15
Added Board Layout and Design Section	15
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Added Choosing a Shunt Resistor Section	15
Added Shunt Resistor Connection Section	16
Added Figure 39 and Figure 40	16

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Change to Figure 1	1
Changes to General Description Section and Table 1	1
Change to Input Voltage Range Parameter, Table 2	3
Changes to Table 3	4
Changes to Typical Performance Characteristics Section	6
Changes to Ordering Guide	. 17
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SPECIFICATIONS

 T_{A} = -40°C to +125°C (operating temperature range), V_{S} = 5 V, unless otherwise noted.

Table 2. Electrical Characteristics

Parameter	Test Conditions/Comments	Min	Тур	Мах	Unit
GAIN					
Initial			60		V/V
Error Over Temperature	Specified temperature range			±0.3	%
Gain vs. Temperature		-10		+10	ppm/°C
VOLTAGE OFFSET					
Offset Voltage, Referred to the Input (RTI)	25°C		±200		μV
Over Temperature, RTI	Specified temperature range			±400	μV
Offset Drift		-0.4	+0.1	+0.4	µV/°C
INPUT					
Input Bias Current			160		μA
Input Voltage Range	Common mode, continuous	-2		+42	V
Common-Mode Rejection Ratio (CMRR)	Specified temperature range, f = dc	90	100		dB
	f = dc to 10 kHz		86		dB
OUTPUT					
Output Voltage Range	$R_L = 25 k\Omega$	0.045		V _S - 0.035	V
Output Resistance			2		Ω
DYNAMIC RESPONSE					
Small Signal −3 dB Bandwidth			250		kHz
Slew Rate			1		V/µs
NOISE					
0.1 Hz to 10 Hz, RTI			2.3		µV р-р
Spectral Density, 1 kHz, RTI			110		nV/√Hz
OFFSET ADJUSTMENT					
Ratiometric Accuracy ¹	Divider to supplies	0.499		0.501	V/V
Accuracy, Referred to the Output (RTO)	Voltage applied to $V_{REF}1$ and $V_{REF}2$ in parallel			±1	mV/V
Output Offset Adjustment Range	V _S = 5 V	0.045		V _S - 0.035	V
POWER SUPPLY					
Operating Range		2.7		5.5	V
Quiescent Current Over Temperature	V _{OUT} = 0.1 V dc			8.2	mA
Power-Supply Rejection Ratio		80			dB
TEMPERATURE RANGE					
For Specified Performance					
Operating Temperature Range		-40		+125	°C

¹ The offset adjustment is ratiometric to the power supply when $V_{REF}1$ and $V_{REF}2$ are used as a divider between the supplies.

ABSOLUTE MAXIMUM RATINGS

Table 3. Absolute Maximum Ratings

Parameter	Rating
Supply Voltage	6 V
Input Voltage Range, Survival	
+INx to GND	-3 V to +46 V
-INx to GND	-3 V to +46 V
Differential Input Survival	5.5 V (magnitude)
Reverse Supply Voltage	0.3 V
Operating Temperature Range	-40°C to +125°C
Storage Temperature Range	-65°C to +150°C
Output Short-Circuit Duration	Indefinite

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

ELECTROSTATIC DISCHARGE (ESD) RATINGS

The following ESD information is provided for handling of ESD-sensitive devices in and ESD-protected area only.

Human body model (HBM) per ANSI/ESDA/JEDEC JS-001.

ESD Ratings for the AD8417-2

Table 4. AD8417-2, 10-Ball WLCSP

Model	Withstand Threshold (V)	Class
HBM	±2000	2

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



Figure 3. Pin Configuration

Table 5. Pin Function Descriptions

Pin No.	Mnemonic	Description
A1	-INA	Negative Input, Channel A
A3	V _{REF} 2	Reference Input 2
B2	GND	Ground
C1	+INA	Positive Input, Channel A
C3	OUTA	Output, Channel A
D1	-INB	Negative Input, Channel B
D3	V.	Supply
E2	V _{REF} 1	Reference Input 1
F1	+INB	Positive Input, Channel B
F3	OUTB	Output, Channel B



Figure 4. Typical Offset Voltage Drift vs. Temperature











Figure 7. Typical Small Signal Bandwidth (V_{OUT} = 200 mV p-p)



Figure 8. Total Output Error vs. Differential Input Voltage



Figure 9. Bias Current per Input Pin vs. V_{CM}



Figure 10. Supply Current vs. Input Common-Mode Voltage



Figure 11. Rise Time (V_S = 2.7 V)











Figure 14. Fall Time (V_S = 5 V)



Figure 15. Differential Overload Recovery, Rising (V_S = 2.7 V)



Figure 16. Differential Overload Recovery, Rising (V_S = 5 V)



Figure 17. Differential Overload Recovery, Falling (V_S = 2.7 V)



Figure 18. Differential Overload Recovery, Falling (V_S = 5 V)



Figure 19. Input Common-Mode Step Response (V_S = 5 V, Inputs Shorted)







Figure 21. Maximum Output Source Current vs. Temperature



Figure 22. Output Voltage Range from Positive Rail vs. Output Source Current



Figure 23. Output Voltage Range from Ground vs. Output Sink Current



Figure 24. Offset Voltage Distribution



Figure 25. CMRR vs. Temperature



Figure 26. Gain Error Drift Distribution

THEORY OF OPERATION

The AD8417-2 is a single-supply, zero drift, difference amplifier that uses a unique architecture to accurately amplify small differential current shunt voltages in the presence of rapidly changing common-mode voltages.

The AD8417-2 design provides excellent common-mode rejection, even with PWM common-mode inputs that can change at very fast rates, for example, 1 V/ns. The AD8417-2 contains patented (U.S. Patent 8,624,668 B2) technology to eliminate the negative effects of such fast changing external common-mode variations.

The AD8417-2 features an input offset drift of less than $0.4 \ \mu V/^{\circ}C$. This performance is achieved through a novel zero drift architecture that does not compromise bandwidth, which is typically rated at 250 kHz.

The reference inputs, $V_{REF}1$ and $V_{REF}2$, are tied through 100 k Ω resistors to the positive input of the main amplifier, which allows the output offset to be adjusted anywhere in the output operating range. The gain is 1 V/V from the reference pins to the output when the reference pins are used in parallel. When the pins are used to divide the supply, the gain is 0.5 V/V.

The AD8417-2 offers breakthrough performance without compromising any of the robust application needs typical of solenoid or motor control. The ability to reject PWM input common-mode voltages and the zero drift architecture providing low offset and offset drift allows the AD8417-2 to deliver total accuracy for these demanding applications.

OUTPUT OFFSET ADJUSTMENT

The output of the AD8417-2 can be adjusted for unidirectional or bidirectional operation.

UNIDIRECTIONAL OPERATION

Unidirectional operation allows the AD8417-2 to measure currents through a resistive shunt in one direction. The basic modes for unidirectional operation are ground referenced output mode and V_S referenced output mode.

For unidirectional operation, the output can be set at the negative rail (near ground) or at the positive rail (near V_S) when the differential input is 0 V. The output moves to the opposite rail when a correct polarity differential input voltage is applied. The required polarity of the differential input depends on the output voltage setting. If the output is set at the positive rail, the input polarity must be negative to decrease the output. If the output is set at ground, the polarity must be positive to increase the output.

Ground Referenced Output Mode

When using the AD8417-2 in ground referenced output mode, both referenced inputs are tied to ground, which causes the output to sit at the negative rail when there are zero differential volts at the input (see Figure 27).



Figure 27. Ground Referenced Output

V_S Referenced Output Mode

 V_S referenced output mode is set when both reference pins are tied to the positive supply. It is typically used when the diagnostic scheme requires detection of the amplifier and the wiring before power is applied to the load (see Figure 28).



Figure 28. V_S Referenced Output

BIDIRECTIONAL OPERATION

Bidirectional operation allows the AD8417-2 to measure currents through a resistive shunt in two directions.

In this case, the output is set anywhere within the output range. Typically, it is set at half scale for equal range in both directions. In some cases, however, it is set at a voltage other than half scale when the bidirectional current is nonsymmetrical.

Apply voltage(s) to the referenced inputs to adjust the output. $V_{REF}1$ and $V_{REF}2$ are tied to internal resistors that connect to an internal offset node. There is no operational difference between the pins.

EXTERNAL REFERENCED OUTPUT

Tying both pins together and to a reference produces an output equal to the reference voltage when there is no differential input (see Figure 29). The output decreases the reference voltage when the input is negative, relative to the -IN pin, and increases when the input is positive, relative to the -IN pin.



Figure 29. External Referenced Output

OUTPUT OFFSET ADJUSTMENT

SPLITTING THE SUPPLY

By tying one reference pin to V_S and the other to GND, the output is set at half of the supply when there is no differential input (see Figure 30). The benefit of this configuration is that an external reference is not required to offset the output for bidirectional current measurement. Tying one reference pin to V_S and the other to GND creates a mid-scale offset that is ratio-metric to the supply, which means that if the supply increases or decreases, the output remains at half the supply. For example, if the supply is 5.0 V, the output is at half scale, or 2.5 V. If the supply increases by 10% (to 5.5 V), the output increases to 2.75 V.



Figure 30. Split Supply

SPLITTING AN EXTERNAL REFERENCE

Use the internal reference resistors to divide an external reference by 2 with an accuracy of approximately 0.2%. Split an external reference by connecting one $V_{REF}x$ pin to ground and the other $V_{REF}x$ pin to the reference (see Figure 31).



Figure 31. Split External Reference

APPLICATIONS INFORMATION

MOTOR CONTROL

3-Phase Motor Control

The AD8417-2 is ideally suited for monitoring current in 3-phase motor applications.

The 250 kHz typical bandwidth of the AD8417-2 provides instantaneous current monitoring. Additionally, the typical low offset drift of 0.1 μ V/°C means that the measurement error between the two motor phases is at a minimum over temperature. The AD8417-2 rejects PWM input common-mode voltages in the –2 V to +42 V (with a 5 V supply) range. Monitoring the current on the motor phase allows sampling of the current at any point and provides diagnostic information, such as a short to GND and the battery. See Figure 33 for the typical phase current measurement setup with the AD8417-2.

H-Bridge Motor Control

Another typical application for the AD8417-2 is to form part of the control loop in H-bridge motor control. In this case, place the shunt resistor in the middle of the H-bridge to accurately measure current in both directions by using the shunt available at the motor (see Figure 32). Using an amplifier and shunt in this location is a better solution than a ground referenced op amp because ground is not typically a stable reference voltage in this type of application. The instability of the ground reference causes inaccuracies in the measurements that can be made with a simple ground referenced op amp. The AD8417-2 measures current in both directions as the H-bridge switches and the motor changes direction. The output of the AD8417-2 is configured in an external referenced bidirectional mode (see the Bidirectional Operation section).



Figure 32. H-Bridge Motor Control



Figure 33. 3-Phase Motor Control

APPLICATIONS INFORMATION

SOLENOID CONTROL

High-Side Current Sense with a Low-Side Switch

In the case of a high-side current sense with a low-side switch, the PWM control switch is ground referenced. Tie an inductive load (solenoid) to a power supply and place a resistive shunt between the switch and the load (see Figure 34). An advantage of placing the shunt on the high side is that the entire current, including the recirculation current, is measurable because the shunt remains in the loop when the switch is off. In addition, diagnostics are enhanced because shorts to ground are detected with the shunt on the high side.

In this circuit configuration, when the switch is closed, the commonmode voltage decreases to near the negative rail. When the switch is open, the voltage reversal across the inductive load causes the common-mode voltage to be held one diode drop above the battery by the clamp diode.



Figure 34. Low-Side Switch

High-Side Current Sense with a High-Side Switch

The high-side current sense with a high-side switch configuration minimizes the possibility of unexpected solenoid activation and excessive corrosion (see Figure 35). In this case, both the switch and the shunt are on the high side. When the switch is off, the battery is removed from the load, which prevents damage from potential shorts to ground while still allowing the recirculating current to be measured and to provide diagnostics. Removing the power supply from the load for the majority of the time that the switch is open minimizes the corrosive effects that can be caused by the differential voltage between the load and ground.

When using a high-side switch, the battery voltage is connected to the load when the switch is closed, causing the common-mode voltage to increase to the battery voltage. In this case, when the switch is open, the voltage reversal across the inductive load causes the common-mode voltage to be held one diode drop below ground by the clamp diode.



Figure 35. High-Side Switch

High Rail Current Sensing

In the high rail current sensing configuration, the shunt resistor is referenced to the battery. High voltage is present at the inputs of the current sense amplifier. When the shunt is battery referenced, the AD8417-2 produces a linear ground referenced analog output. Additionally, the AD8214 provides an overcurrent detection signal in as little as 100 ns (see Figure 36). This feature is useful in high current systems where fast shutdown in overcurrent conditions is essential.



Figure 36. High Rail Current Sensing

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LAYOUT RECOMMENDATION

With the increase in device functionality and decrease in the size of the device in a WLCSP package, the board fabrication may become more complex. The AN-617 Application Note, *Wafer Level Chip Scale Package*, has information on the printed circuit board (PCB) layout and assembly as well as the critical board design parameters for WLCSP.

BOARD LAYOUT AND DESIGN

The AD8417-2 offers a simple array that allows routing on the surface layer of the board. In a bidirectional motor control application, the $V_{REF}1$ pin is typically tied to the V+ pin and the $V_{REF}2$ pin is typically tied to the GND pin. This allows the AD8417-2 in a WLCSP to simply be routed on a single layer of the PCB. Figure 37 shows a simple PCB routing scheme for a single layer layout.



Figure 37. Recommended Routing for Bidirectional Motor Control

Figure 38 illustrates an example arrangement for a bidirectional operation that is exclusively routed within the top layer of the PCB. This example layout can be use as a reference for AD8417-2 board. Typically in motor control applications, at least two current measurements are needed for precise motor control (as shown in Figure 33). This solution represents a streamlined layout for measuring two motor phase currents in bidirectional motor control, making efficient use of the compact dimensions of the AD8417-2. The design occupies 30.861 mm × 34.798 mm (1.215 in × 1.370 in) of PCB space without compromising performance, enabling a more space efficient and cost-effective motor design.



Figure 38. Sample PCB Layout for Bidirectional Operation

CHOOSING A SHUNT RESISTOR

There are different factors to consider in selecting the appropriate shunt resistor, including the resistor value, size, cost, tolerance, power dissipation, and thermal drift.

Commonly, the resistor value is selected based upon the desired maximum differential voltage generated at the highest expected current, while considering the power loss budget. Another consideration is to ensure the output is maximized at full-scale current, taking full advantage of the available system dynamic range. Choosing the shunt resistor (R_{SHUNT}) value is often a compromise between these two considerations.

$$R_{SHUNT} = V_{DIFF, MAX} / I_{MAX}$$
(1)

The shunt resistor tolerance directly affects the accuracy of the overall gain error of the current measurement. The AD8417-2 is specified to have a maximum gain error of 0.3% over the specified temperature range from -40° C to $+125^{\circ}$ C. For optimal performance, select a 0.1% shunt resistor (or with lower tolerance) that does not introduce more gain error than the AD8417-2.

The power dissipation in the shunt resistor is calculated using the following equation:

$$P = l^2 R$$

Thus, a higher resistance results in higher power dissipation. Power dissipation in the shunt resistor leads to self heating, resulting in an increase in the temperature of the shunt resistor. Any change in shunt resistor temperature because of self heating can result in a nonlinear error. Selecting a shunt resistor with a low temperature coefficient minimizes any self heating of the shunt and minimizes any thermal nonlinearity.

The thermal drift of the voltage developed across the shunt resistor varies in relationship to the power dissipated by the resistor.

(2)

LAYOUT RECOMMENDATION

SHUNT RESISTOR CONNECTION

The shunt resistor is connected between the input pins for either channel of the current sense amplifier, which is shown in Figure 39. Figure 39 shows the shunt resistor (R_{SHUNT_A}) connected to Channel A and the shunt resistor (R_{SHUNT_B}) connected to Channel B. Typically, the shunt resistor has a very low resistance. Hence, it is recommended to use a 4-wire Kelvin connection on the shunt to achieve high accuracy current sense measurement. A proper Kelvin connection avoids sensing across any parasitic PCB trace resistance.



Figure 39. Shunt Resistor Schematic

There are different ways to make the Kelvin connection to the R_{SHUNT} resistor. Figure 40 shows a test board of five different layouts to verify which is the best layout to optimize high-current sensing accuracy. Based on the Analog Dialogue article, "Optimize High-Current Sensing Accuracy by Improving Pad Layout of Low-Value Shunt Resistors" (Volume 46, June 2012), the sense points must be considered by placing them at the outer extremity of the resistor. The article shows that it was experimentally determined that the layouts with the lowest errors are Style C and Style D. The Style C layout is preferred because component placement tolerance issues are less likely to arise. Without a Kelvin connection, measuring on the top pad, there is about a 22.8% error. Therefore, it is better to use a Kelvin connection when using a low value shunt resistor to obtain more accurate current sense measurements.



Figure 40. Sample R_{SHUNT} Board Layout

OUTLINE DIMENSIONS



Figure 41. 10-Ball Wafer Level Chip Scale Package [WLCSP] (CB-10-2) Dimensions shown in millimeters

Updated: June 02, 2023

ORDERING GUIDE

Model ¹	Temperature Range	Package Description	Packing Quantity	Package Option	Marking Code
AD8417-2ACBZ-R7	-40°C to +125°C	CHIPS W/SOLDER BUMPS/WLCSP	Reel, 3000	CB-10-2	Y78

¹ Z = RoHS Compliant Part.

